

PRODUCT / PROCESS CHANGE NOTIFICATION

PCN-000458

Date: 26OCT2017 P1/1

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		Court, Great Park Road, Bristol		
☐ Semtech Corpus Christi	SA de CV, Carretera Matamo	rros Edificio 7, Reynosa, Tam		
Semtech Plano, 1101 Re	esource Drive, Suite 121, Plan			
	Change			
Part Number(s) Affector EClamp2357NQ	Part Number(s) Affected:			
Description, Purpose and Effect of Change: Description: This is an Ordering Part Number change in the data sheet. Added: EClamp2357NQTLT; available in 12 mm wide carrier tape. Removed: EClamp2357NQTCT Purpose: The purpose of the change is improved tape and reel quality and compliance with EIA-481 – Tape and Reel Spec. This spec calls for EClamp2357NQ to be taped into a 12 mm carrier tape.				
Change Classification	⊠ Major ☐ Minor	Impact to Form, Fit, Function	☐ Yes ⊠ No	
Impact to Data Sheet	⊠ Yes □ No	New Revision or Date	160CT2017 🗌 N/A	
Impact to Performance, Characteristics or Reliability: There is no impact to Form, Fit, Function or Reliability performance of the part. This is a datasheet change to identify a new ordering Part Number.				
Implementation Date	27OCT2017	Work Week	TBA	
Last Time Ship (LTS) Of unchanged product	No longer available	Affecting Lot No. / Serial No. (SN)	N/A	
Sample Availability	27OCT2017	Qualification Report Availability	27OCT2017	
Supporting Documents for Change Validation/Attachments: • New Datasheet for EClamp2357NQ				
Issuing Authority				
Semtech Business Unit	: Protection Business I	Unit		
Semtech Contact Info:	emtech Contact Info: Les Fang Yuen Semtech Corporation Sr. Engineering Manager, QA 200 Flynn Road Camarillo, CA 93012 Ifangyuen@semtech.com Office: (949) 269-4443		ang ynen	
FOR FURTHER INFORMATION & WORLDWIDE SALES COVERAGE: http://www.semtech.com/contact/index.html#support				





EMIClamp® EMI Filter and ESD Protection For SD Card Interfaces

PROTECTION PRODUCTS

Description

The EClamp*2357NQ is a low pass filter array with integrated TVS diodes. It is designed to suppress unwanted EMI/RFI signals and provide electrostatic discharge (ESD) protection in portable electronic equipment. They have been optimized for protection of touch screen displays, secure digital (SD) card interfaces, and color LCD panels in cellular phones and other portable electronics.

The device consists of six π filter circuits comprised of TVS diodes for ESD protection, and a resistor capacitor network for EMI/RFI filtering. A series resistor value of 100Ω and a component capacitance value of 10pF are used to achieve 20dB minimum attenuation from 1.0GHz to 3GHz. The device also includes 4 discrete TVS diodes for dedicated ESD protection. All of the TVS diodes provide effective suppression of ESD voltages in excess of $\pm 20kV$ (air discharge) and $\pm 12kV$ (contact discharge) per IEC 61000-4-2, level 4.

The EClamp2357NQ is qualified to AEC-Q100 Grade 1 for automotive use.

Features

- EMI/RFI filter with integrated ESD protection
- ESD protection to IEC 61000-4-2 (ESD) Level 4, ±20kV (air), ±12kV (contact)
- Filter performance: >30dB attenuation at 1.8GHz
- TVS working voltage: 2.5V
- Resistor: $100\Omega + / 15\%$
- Capacitance: 10pF typ. $(V_R = 0V \text{ for non filter pins})$
- EMI & ESD protection for six lines
- Dedicated ESD protection for four lines
- Solid-state technology
- · AEC-Q100 Grade 1 Qualified

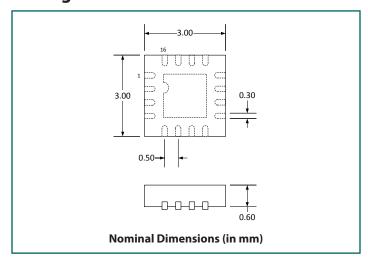
Mechanical Characteristics

- SLP3030P16 package
- Pb-Free, Halogen Free, RoHS/WEEE compliant
- Nominal Dimensions: 3.0 x 3.0 x 0.6 mm
- · Lead Pitch: 0.5mm
- · Lead Finish: Matte Tin
- Marking: Marking Code
- Packaging: Tape and Reel per EIA 481

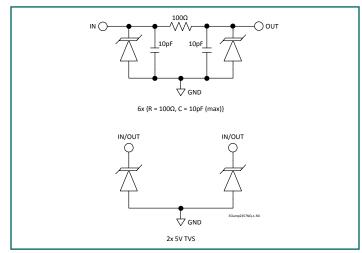
Applications

- Touch Screen Display Interfaces
- Secure Digital (SD) Memory Card Interfaces
- Multimedia Card Interfaces (MCI)
- Color LCD Panel Protection
- Cell Phone Handsets and Accessories
- Automotive Applications

Package Dimensions



Schematic & Pin Configuration



Rev 2.0

Absolute Maximum Ratings

Rating	Symbol	Value	Units
ESD per IEC 61000-4-2 (Contact) ⁽¹⁾	V	±12	LAZ
ESD per IEC 61000-4-2 (Air) ⁽¹⁾	V _{ESD}	±20	kV
Junction Temperature	T,	125	°C
Operating Temperature	T _{OP}	-40 to +125	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C unless otherwise specified)

Parameter	Symbol	Conditions		Min.	Тур.	Max.	Units
Reverse Stand-Off Voltage	V _{RWM}	-40°C to 125°C, any I/O to GND				2.5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA, any I/O to GND	-40°C to 125°C	6	8	10	V
Reverse Leakage Current	I _R	V _{RWM} = 2.5V, any I/O to GND	-40°C to 125°C			0.5	μΑ
Total Series Resistance	R	Each line, T = -40 °C to 125 °C		85	100	115	Ω
Total Capacitance	C _{IN}	Input to Gnd, each Line, $f = 1 \text{ MHz}$ $\frac{V_R = 0V}{V_R = 2.5V}$	$V_R = 0V$		20	22	,, F
			V _R = 2.5V		12	15	pF

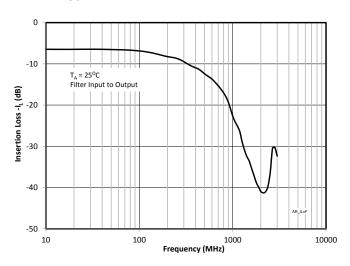
Notes:

(1): ESD Gun return path to Ground Reference Plane (GRP)

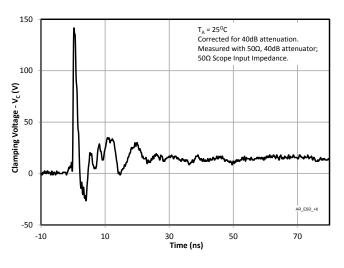
Rev 2.0

Typical Characteristics

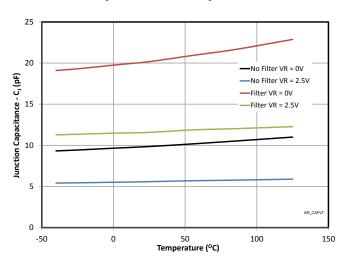
Typical Insertion Loss -S21 (Each Filter)



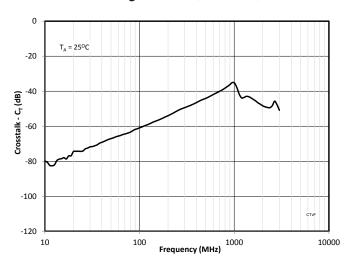
ESD Clamping (+8kV Contact per IEC 61000-4-2)



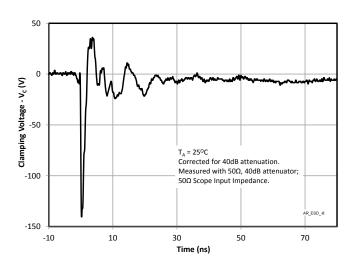
Capacitance vs. Temperature



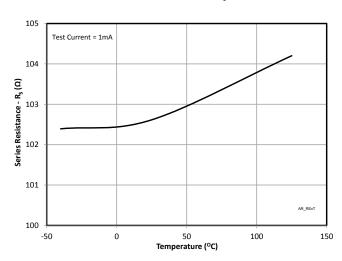
Analog Crosstalk (Each Line)



ESD Clamping (-8kV Contact per IEC 61000-4-2)

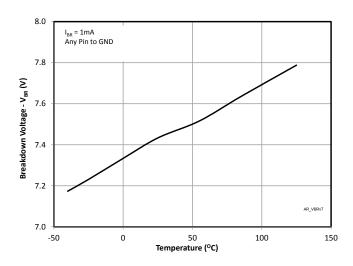


Series Resistance vs. Temperature

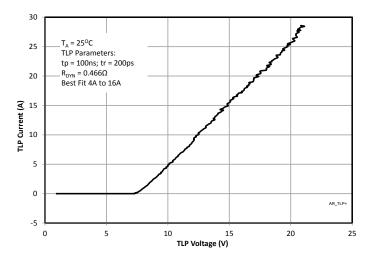


Typical Characteristics (Continued)

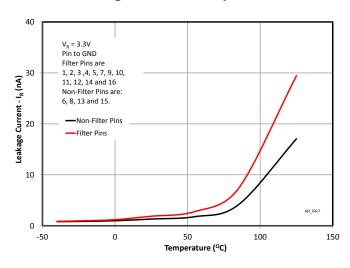
Breakdown Voltage vs. Temperature



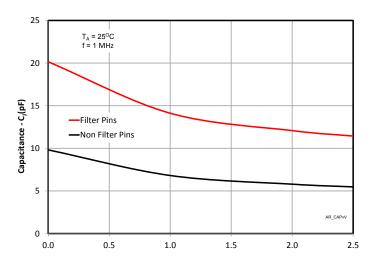
TLP Characteristics (Positive)



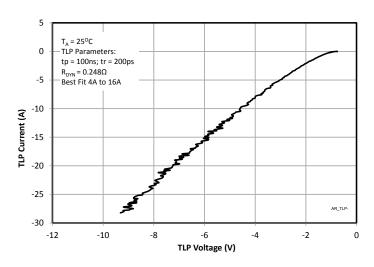
Leakage Current vs. Temperature



Capacitance vs. Reverse Voltage



TLP Characteristics (Negative)



Application Information

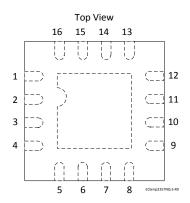
Device Connection

The EClamp2357NQ is comprised of six circuits each consisting of a low pass filter for EMI/RFI suppression and dual TVS diodes for ESD protection. It also includes 4 lines of TVS diodes for ESD protection of power lines or high speed I/O lines. The device is housed in a 16-pin Quad Flat No-Lead (QFN) package. Electrical connection is made via 16 pins located at the bottom of the device. A center tab serves as the ground connection. Pin connections are noted in the table to the right. The device is designed for easy PCB routing as shown in the application examples. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces.

Matte Tin Lead Finish

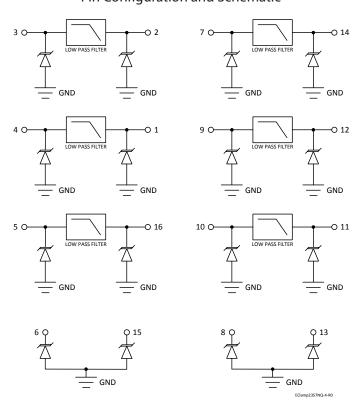
Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.

Pin Identification and Configuration (Top Side View)



Pin	Identification
3, 4, 5, 7, 9, 10	Input EMI/ESD Protected Lines
1, 2, 11, 12, 14, 16	Output EMI/ESD Protected Lines
6, 8, 13, 15	Input/Output ESD Protected Lines
Center Tab	Ground

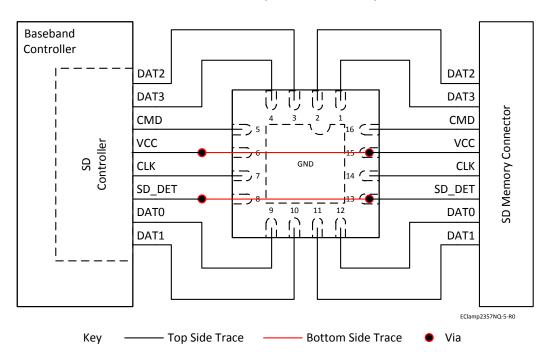
Pin Configuration and Schematic



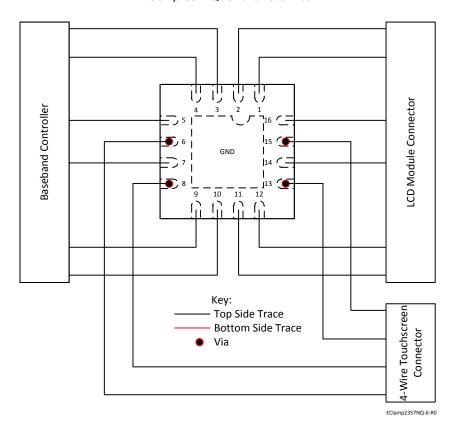
Rev 2.0

Application Information

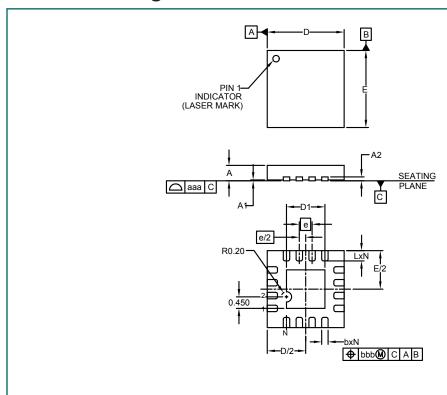
EClamp2357NQ SD Memory



EClamp2357NQ LCD and Touch Pad



Outline Drawing - SLP3030P16

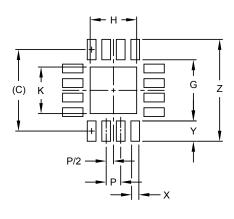


DIMENSIONS			
DIM MILLIMETE			TERS
ווווט	MIN	NOM	MAX
Α	0.55	0.60	0.65
A1	0.00	0.02	0.05
A2	-	(0.15)	
р	0.20	0.25	0.30
D	2.90	3.00	3.10
D1	1.40	1.50	1.60
Е	2.90	3.00	3.10
E1	1.40	1.50	1.60
е	0.50 BSC		
L	0.35	0.40	0.45
N	16		
aaa	0.08		
bbb	0.10		

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

Land Pattern - SLP3030P16

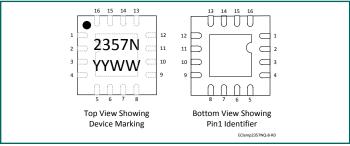


DIMENSIONS		
DIM	MILLIMETERS	
С	(2.80)	
G	2.10	
Н	1.60	
K	1.60	
Р	0.50	
Χ	0.30	
Υ	0.70	
Ζ	3.50	

NOTES:

- THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
 CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR
 COMPANY'S MANUFACTURING GUIDELINES ARE MET.
- 2. DO NOT PLACE VIAS BETWEEN THE CORNER LEADS INSIDE THE 3X3MM PACKAGE FOOTPRINT.
- 3. THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.

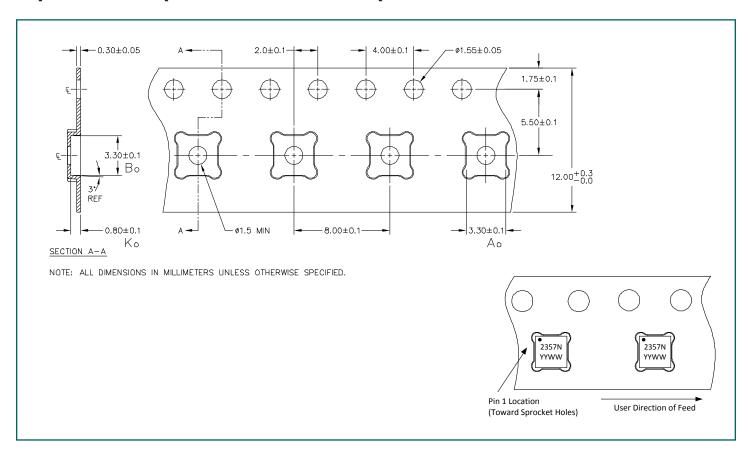
Marking Code



Notes:

- 1. YYWW = Alphanumeric character Date Code
- 2. Pin 1 indicated by "Mouse Bite" on the ground pad

Tape and Reel Specification - Plastic Tape



Ordering Information

Part Number	Qty per Reel	Reel Size
EClamp2357NQTLT	3000	13 Inch
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